

Title (en)
METHOD FOR LAYING FLOOR PANELS

Title (de)
VERFAHREN ZUM VERLEGEN VON FUSSBODENPANEELN

Title (fr)
PROCÉDÉ D'APPLICATION DE PANNEAUX DE SOL

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Application
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Abstract (en)
[origin: CA2715964A1] The invention relates to a method for laying floor panels (1.n, 2.n, ...) in a room to form a closed floor area on a laying plane (E v) without using an adhesive, said floor panels especially consisting of a wood material, such as MDF or HDF, and having matching corresponding profiles on opposite longitudinal edges (I, I') and transverse edges (II, II'). The closed floor area is obtained by interconnecting a plurality of panels (1.1, 1.2, ..., 2.1, 2.2, ...) on their transverse edges (II, II') to give a row (R3) and on their longitudinal edges (I, I') to give a plurality of rows (R n) and then locking them in relation to each other.

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